

EEPC Invites Participation for MSV 2007, Brno, Czech Republic (October 1 - 5, 2007)

MSV 2007 (49th International Engineering Fair) is the largest Technology Trade Fair in Central Europe. It is a holistic platform for the engineering industry co-locating manufacturers of machine tools and forming machinery along with material and component manufacturers with applications in automation, building and construction, engineering and electronics, and measuring instruments. There is great scope for Industrial machinery, given the upsurge in users from the automotive and electrical engineering industries. MSV 2007, Brno is scheduled to be held from 1 to 5 October, 2007 at Brno, Czech Republic.

It attracts 96,000 visitors from all over the world, more than 13% are from abroad. A highly competent visiting clientele, almost 90% are trade professionals, 78% of visitors decide, co-decide or advise on purchases and investments.

The export of engineering goods from India to European countries has reached a level of US\$ 4.40 billion in 2005-06 against a value of US\$ 3.95 million during 2004-05 thereby registering a growth of 11.14%. The last three years trend indicates an average growth of 36.78%. This shows that the Indian engineering goods are regularly finding a favourable place in European market.

Engineering Export Promotion Council (EEPC) is inviting participation for India Pavilion at MSV 2007, Brno which would provide an excellent opportunity for business relationships with customers from all over the world.

Focus Products

Main focus of the Council would be on the following items :

Metal : Machine tools and equipment; forming machines; hand-operated tools; manual non-mechanized tools; metal surface finish equipment; welding machines and additional materials; machines and equipment for fine mechanics and optics; and machines for other metalworking products.

Materials and components for mechanical engineering : Metallurgical semi-products, forgings, pressings, castings, and work pieces; connecting materials, fittings, and products of wire; steel and tube structures; apparatuses, vessels and tanks; seals and bearings; gears, clutches, brakes, and lubricating technology.

Plastics, rubber technology & chemical industry : Machinery and accessories for the chemical industry; machines and equipment for plastics and rubber processing; semi-products, intermediates, and organic and inorganic chemical products; lubricants, oils, coating compositions, cements, and adhesives; chemicals for industrial products.

Venue

Central European Exhibition Centre, Brno, Czech Republic

Date

1 - 5 October, 2007 (5 days)

Participation Charges

Built-up booths minimum 9 sq. mtrs. : Rs. 17,500/- per sq. mtr. (row stand, one side open).

20% extra for corner, 3-side open, and island site space allocations.

Display Booth

Participation charge includes following services :

- Fascia
- Carpeting
- One Table
- Four Chairs
- One Hat + Coat Rack
- Electricity – Three 100W Spotlights
- One Waste Basket

Mode of Payment

Full payment is to be made by Demand Draft/at par Cheque favouring “Engineering Export Promotion Council” along with the filled-up Application Form.

Date of Payment

Full payment is to be made along with the **Application Form latest by 16th July, 2007.**

Cancellation of Participation

Request for cancellation of participation will be accepted if Council receives the same in writing on or before **30th July, 2007.** Council shall not entertain any cancellation afterwards. Any cancellation after the due date shall result in forfeiture of the amount already paid on this account.

Selection Criteria

Since limited space is available, selection of participation will be done strictly on *first-come-first served* basis.

MDA Entitlements

All eligible participants will be entitled to get MDA Grant as per the MDA Guidelines effective from April 01, 2006. Assistance would be permissible on charges of built-up furnished stall subject to an upper ceiling of Rs. 80,000/-.

Further, eligibility for MDA Grant is subject to exporting companies having FOB value of exports up to Rs. 15 crores in the preceding year, having complete 12 months membership with EEPC with regular filing of returns and fulfilling other conditions, details of which can be obtained from Council's Website : www.eepcindia.org or respective Regional and Sub-Regional Offices of EEPC.

Interested firms may please send the **Application Form**, duly filled in and signed, along with full payment **latest by 16th July, 2007** to the respective Regional Offices or to :

Opinder Singh

Assistant Director

Engineering Export Promotion Council

Plot Comm. 1, Focal Point

Jalandhar 144 004

Tel. : (+91 181) 2602264, 2601124

Fax : (+91 181) 2601124

E-mail : eepcjal@vsnl.com

enggc_jld@dataone.in

or log on to : www.eepcindia.org

Application Form

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Name of the Company	:			
Postal Address	:			
Phone (with area code)	:			
Fax (with area code)	:			
E-mail	:			
Website	:			
Total Space required	:			
Amount with DD/Cheque No. & Date	:			
Name & Designation of the Chief Executive	:			
Name & Designation of the Participant	:			
Type of Units (please tick mark)	:	<input type="checkbox"/> SSI	<input type="checkbox"/> Non-SSI	
Status (please tick mark)	:	<input type="checkbox"/> Manufacturer/Exporter	<input type="checkbox"/> Merchant Exporter	<input type="checkbox"/> Export House
Total Annual Export (in Million US\$)	:	<u>2004-2005</u>	<u>2005-2006</u>	<u>2006-2007</u>
Total Export to European countries (in Million US\$)	:	<u>2004-2005</u>	<u>2005-2006</u>	<u>2006-2007</u>
Foreign Collaboration, if any	:			
Products Manufactured/Exported	:			
Countries of Export	:			
Accreditation to International Standards (like ISO, QS, etc.)	:			

1. Please use separate sheet to furnish details of your company (**within 80 words**) for the Exhibitors' Profile.
2. Please send us this Form duly completed and signed along with your participation fees by Demand Draft/Cheque and 2 (two) copies of passport size colour photographs of the Participant.

Signature : _____

Date : _____ Office Seal : _____